

2 March Incubation Committee Agenda & Notes

Meeting begins at 8am Pacific Standard Time

GTM: <https://global.gotomeeting.com/join/435728477>

2:00	Call to Order	Michael Schill		
2:00 - 2:20	TAP Specs Receiver Carrier Board, Large Oscillator Form-factor	Elad Wind, Ahmad Byagowi	NVIDIA, Meta	Receiver Carrier Board Spec Large Oscillator Form-factor Spec Presentation Action - move to review on 3/3/23
2:20 - 2:35	Datacenter SAS-SATA Device Specification	Ross Stenfort, Lee Prewitt, Paul Kaler	Meta, Microsoft, HPE	Datacenter SAS-SATA Device Spec Presentation Action - move to review on 3/3/23
2:35 - 3:00	OCP OAI-OAM Base Spec Update OCP OAI-UBB Base Spec Update	Song Kok Hang	OAI Group	OCP OAI-OAM Base Spec OCP OAI-UBB Base Spec Presentation Action - move to review on 3/3/23
Waiting List				

Invitees (Names in Bold indicates who attended, in Blue indicates new):

If you join after the call has started please take a moment to indicate that you attended by changing your name to bold font.

- George Tchapanian (CEO)
- **Bijan Nowroozi (CTO)**
- Bill Carter (OCP -Interim)
- Cliff Grossner (VP Market Intelligence)
- Steve Helvie (VP Channel)
- Dirk Van Slyke (Chief Marketing Officer)
- Kali Burdette (Dir of Global Events)
- Kate Hendle (Events Manager)
- Kevin Kiefer (IT Manager)
- Michael Schill (Community Director)

IC Members

- Jeff Catlin (Celestica) - IC Co-Chair
- Jessica Gulbrand (Intel) IC Co-Chair
- Dharmesh Jani (Meta) - IC Co-Chair -
- Justin Steadman (Rackspace) - Data Center Facility
- John Leung (Intel) - Hardware Management
- Colin Dupre - Rack & Power
- Siamak Tavallaei (Google) - Server
- Jason Adrian (Microsoft) -Storage
- Craig White (Nokia) - Telco
- Dong Wei (ARM) - OSF
- Andres Lagar-Cavilla (Google) - Security
- Elad Wind (NVidia) - TAP
- Steve Mills (Meta) - Cooling Environments
- Eric Dahlen (Intel) Sustainability

Project Leads

- Hemal Shah (Broadcom) - Hardware Management
- Bob Stevens (Dell) - Hardware Management
- Ravinder Sunkad (Meta) - Networking
- Barak Gafni (Nvidia) - Networking
- Steve Moore (Rittal) - Rack & Power
- Hamid Keyhani (Meta) - Rack & Power
- Brett Lehman (PCX) - DCF
- Madhu Iyengar (Google) - DCF
- Mark A Shaw (Microsoft) - Server
- John Stuewe (Dell) - Server
- Ross Stenfort (Meta) - Storage
- Amber Huffman (Google) - Storage
- Ripin Checker (Cisco) - Telco
- Loren Staley (Edgecore)) - Telco
- Jeff Anderson (Google) - Security
- Bryan Kelly (Microsoft) - Security
- Jonathan Zhang (Meta)- OSF
- Ahamad Byagowi (Meta) - TAP
- Sean Sivapalan (Intel) - Cooling Environments
- Don Mitchell (Victaulic) - Cooling Environments
- Xin Liu (Microsoft) - SONiC/SAI Subgroup
- Alex Doyle (NVIDIA) - ONIE
- Qian Wang (Intel) - HW Mgmt Modules
- Eric Shobe (DB) - HW Mgmt Modules
- Han Wang (Inspur) - OpenRMC

- Ahmed Abou-Alfotouh (AMD) - OAI
- Song Kok Hang (Meta) - OAI
- Bapi Vinnakota (Broadcom) - ODSA
- ODSA Colead - TBD
- Allan Cantle (Nallasway) HPC
- Tanveer Saad (Nokia) - Edge
- Damien Chong Kong (Meta) - NIC/Mezz
- Glenn Charest (Meta) ORV3 Blind Mate
- Brandon Gries (CEI) - MDC
- Karl Rabe (self) - MDC
- Rolf Brink (self) - ACS Immersion Cooling
- John Bean (GRC) - ACS Immersion Cooling
- John Fernandez (FB) - ACS Door Heat Exchanger

- Jordan Johnson (Intel) - ACS Cold Plate
- John Gross (Individual) - Adv Cooling Facilities (ACF)
- John Menoche (Vertiv) - Adv Cooling Facilities (ACF)
- Zhengyu Yang (Meta) - Hw Fault Mgt
- Yogesh Verma (Intel) - Hw Fault Mgt
- Rama Bhumanadhuni (Microsoft) - Hw Fault Mgmt
- Jack Redpath (independent) - Enterprise Connectivity
- Jeff Strande (Target) - Enterprise Connectivity
- Joey Arato (Meta) - Op Tech Security (OTS)
- Eehern Wong (Google) - Op Tech Security (OTS)

Others:

Notes: *(It's important that everyone who is on the call helps to capture action items and important notes from this call.)*